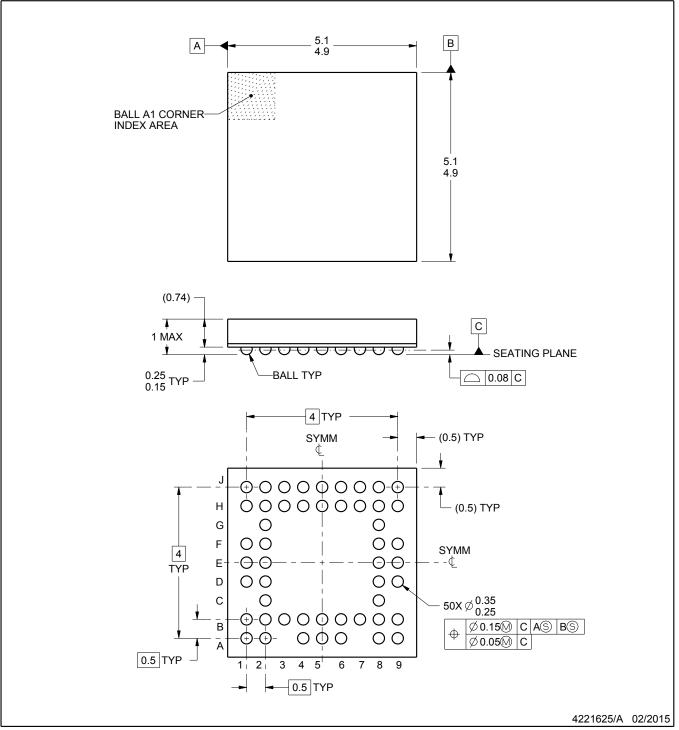
ZQE0050A



PACKAGE OUTLINE

BGA MicroStar Jr [™] - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES:

MicroStar Junior is trademark of Texas Instruments.

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.

3. Reference JEDEC registration MO-225.

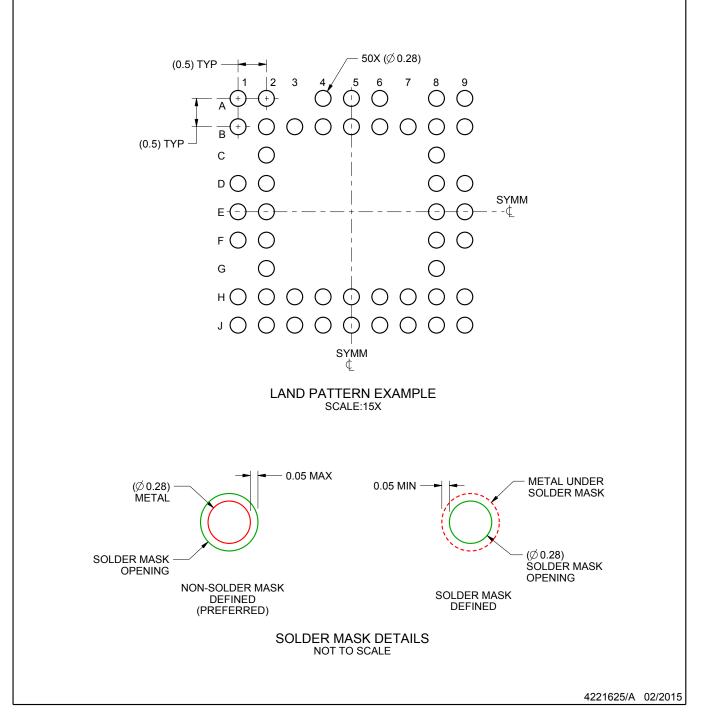


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EXAMPLE BOARD LAYOUT

BGA MicroStar Jr [™] - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SSYZ015 (www.ti.com/lit/ssyz015).

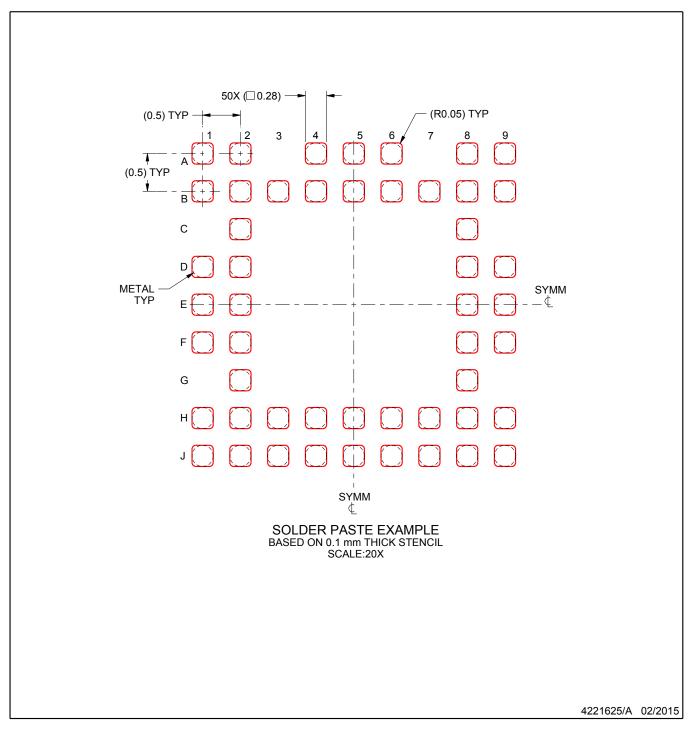


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EXAMPLE STENCIL DESIGN

BGA MicroStar Jr [™] - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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